

**TRANSMITTAL**

Electronic Version v1.1

Stylesheet Version v1.1.0

Title of Invention	ON CHIP RESISTOR CALIBRATION STRUCTURE AND METHOD							
<p>Application Number : _____</p> <p>Date : _____</p> <p>First Named Applicant:           Terence B. Hook</p> <p>Confirmation Number: _____</p> <p>Attorney Docket Number:       BUR920030074US1</p>								
<p>I hereby certify that the use of this system is for OFFICIAL correspondence between patent applicants or their representatives and the USPTO. Fraudulent or other use besides the filing of official correspondence by authorized parties is strictly prohibited, and subject to a fine and/or imprisonment under applicable law.</p> <p>I, the undersigned, certify that I have viewed a display of document(s) being electronically submitted to the United States Patent and Trademark Office, using either the USPTO provided style sheet or software, and that this is the document(s) I intend for initiation or further prosecution of a patent application noted in the submission. This document(s) will become part of the official electronic record at the USPTO.</p>								
<table border="1"><thead><tr><th data-bbox="85 622 493 646">Submitted By:</th><th data-bbox="493 622 708 646">Elec. Sign.</th><th data-bbox="708 622 902 646">Sign. Capacity</th></tr></thead><tbody><tr><td data-bbox="85 646 493 694">Richard A. Henkler Registered Number: 39,220</td><td data-bbox="493 646 708 694">Richard A. Henkler /s/</td><td data-bbox="708 646 902 694">Attorney</td></tr></tbody></table>			Submitted By:	Elec. Sign.	Sign. Capacity	Richard A. Henkler Registered Number: 39,220	Richard A. Henkler /s/	Attorney
Submitted By:	Elec. Sign.	Sign. Capacity						
Richard A. Henkler Registered Number: 39,220	Richard A. Henkler /s/	Attorney						

Documents being submitted:	Files
us-assignment	BUR920030074US1-usassn.xml us-assignment.xsl us-assignment.dtd BUR920030074assign1.tif BUR920030074assign2.tif
us-request	BUR920030074US1-usrequ.xml us-request.dtd us-request.xsl
us-fee-sheet	BUR920030074US1-usfees.xml us-fee-sheet.xsl us-fee-sheet.dtd
us-declaration	BUR920030074dec1.tif
us-declaration	BUR920030074dec2.tif
application-body	BUR920030074spec-trans.xml us-application-body.xsl application-body.dtd wipo.ent mathml2.dtd mathml2-qname-1.mod isoamsa.ent isoamsb.ent isoamsc.ent isoamsn.ent isoamso.ent isoamsr.ent isogr3.ent isomfrk.ent isomopf.ent isomscr.ent isotech.ent isobox.ent isocyr1.ent isocyr2.ent isodia.ent isolat1.ent isolat2.ent isonum.ent isopub.ent mmlextra.ent mmlalias.ent soextblx.dtd BUR920030074US1FIGdrawing1.tif BUR920030074US1FIGdrawing2.tif BUR920030074US1FIGdrawing3.tif BUR920030074US1FIGdrawing4.tif
Comments	